



# SPECIFICATION OF PRODUCT 承认书

CUSTOMER:		
DESCRIPTION:	Piezo Buzzer	_
FUSHENG P/N:	FUET-1625	
CUSTOMER P/N:		
DATE:	2018-8-28	

CUSTOMER	APPROVER	CHECKER
	Yunqing Wu	Bing Yan

## 泰州福声电子科技有限公司

地址:江苏省泰州市海陵区凤凰西路168号

电话: 0086-523-86219066 传真: 0086-523-81601108

邮箱: sales@electronic-tech.cn

网址: www.tzfsdz.com

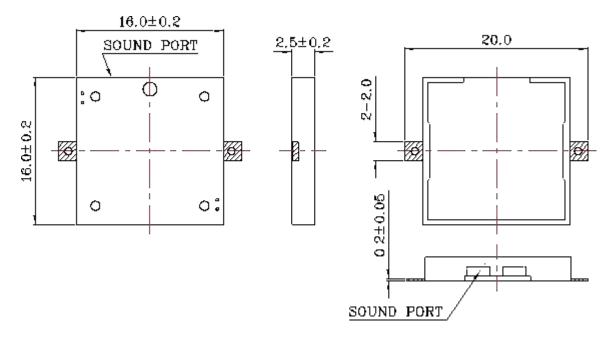




## 1.SPECIFICATION 规格

No.	ltem	Unit	Specification	Condition
1	Oscillation Frequency	Hz	4000	square wave
2	Operating Voltage	Vp-p	1 ~ 25	
3	Rated Voltage	Vp-p	5	
4	Current Consumption	mA	MAX. 2	at Rated Voltage
5	Sound Pressure Level	dB	MIN. 75	at 10cm at Rated Voltage
6	Electrostatic Capacity	pF	16000±30%	at 100Hz 1V
7	Operating Temperature	$^{\circ}\!\mathbb{C}$	-30 ~ +70	
8	Storage Temperature	$^{\circ}\!\mathbb{C}$	-40 ~ +80	
9	Dimension	mm	16.0 x 16.0 x H2.5	See appearance drawing
10	Weight (MAX)	gram	1	
11	Housing Material		LCP( Black )	
12	Leading Pin		Tin Plated Brass(Sn)	See appearance drawing
13	Environmental Protection Regulation		RoHS	

## 2. APPEARANCE DRAWING 尺



Tol: ± 0.3 Unit: mm

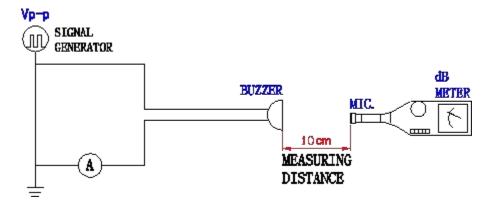
## 3.TESTING METHOD 测量方式

#### **Standard Measurement conditions**

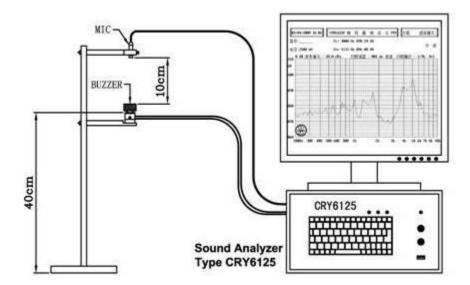
Temperature:25±2°C Humidity:45-65%

#### **Acoustic Characteristics:**

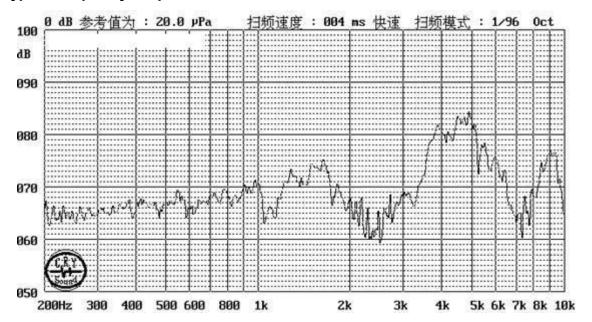
The oscillation frequency, current consumption and sound pressure are measured by the measuring instruments shown below.



In the measuring test, buzzer is placed as follows:



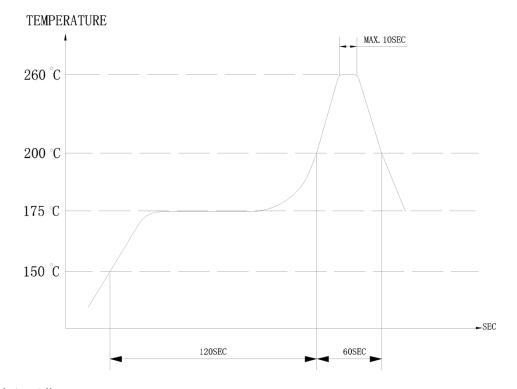
#### 4. Typical Frequency Response Curve



## 5. Soldering Condition

(1) Recommendable reflow soldering condition is as follows (Reflow soldering is twice)

Note: It is requested that reflow soldering should be executed after heat of product goes down to normal.



Heat resistant line

(Used when heat resistant reliability test is performed)

(2)Manual soldering

Manual soldering temperature 350 °C within 5 sec.

## **6. RELIABILITY TEST**

NO.	ITEM	TEST CONDITION AND REQUIREMENT		
1	High Temperature Test (Storage)	After being placed in a chamber with 80 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPLafter test: 10dB.		
2	Low Temperature Test (Storage)	After being Placed in a chamber with -30 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPLafter test: 10dB.		
3	Humidity Test	After being Placed in a chamber with 90-95% R.H. at 40 2°C for 96 hours and then being placed in normal condition for 2 hours.  Allowable variation of SPL after test: 10dB.		
4	Temperature Cycle Test	The part shall be subjected to 5 cycles. One cycle shall be consist of:  +70°C  +25°C  -20°C  -20°C  -20°C  -3hours  Allowable variation of SPLafter test: 10dB.		
5	Drop Test	Drop on a hard wood board of 4cm thick, any directions, 6 times, at the height of 75cm.  Allowable variation of SPLafter test: 10dB.		
6	Vibration Test	After being applied vibration of amplitude of 1.5mm with 10 to 55 Hz band of vibration frequency to each of 3 perpendicular directions for 2 hours.  Allowable variation of SPLafter test: 10dB.		
7	Solderability Test	Lead terminals are immersed in rosin for 5 seconds and then immersed in solder bath of +300 5°C for 3 1 seconds.  90% min. lead terminals shall be wet with solder (Except the edge of terminals).		
8	Terminal Strength Pulling Test	The force of 9.8N(1.0kg) is applied to each terminal in axial direction for 10 seconds.  No visible damage and cutting off.		

#### **TEST CONDITION.**

Standard Test Condition : a) Temperature: +5 ~ +35 ℃ b) Humidity: 45-85% c) Pressure: 860-1060mbar c) 湿度: +5 ~ +35 ℃ b) 湿度: 45-85% c) 气压: 860-1060mbar c) 气压: 860-1060mbar a) 温度: +25 ± 2 ℃ b) Humidity: 60-70% c) Pressure: 860-1060mbar c) 气压: 860-1060mbar c)

